IEEE 802.3da SPMD TF Telephonic Off-cycle Interim meeting 15 June 2022

Prepared by Chad Jones

Agendas, minutes, presentations, etc posted at: https://www.ieee802.org/3/da/index.html

Agenda/Admin - Chad Jones

All times in Eastern Daylight Savings Time (EDT)

10:02am: Meeting commences. The Chair reviewed the agenda deck.

10:03am: The Chair asked if there were any corrections or additions to the agenda. There being no corrections or additions, the agenda stands approved.

10:04am: The Chair asked if anyone hasn't had a chance to review the minutes for the May 2022 Interim Series. None responded. The Chair asked if there were any change to be made to these minutes. None responded. The May 2022 minutes were approved by unanimous consent.

10:05am: Agenda deck continues. From the "INSTRUCTIONS FOR THE WG CHAIR" slide in https://www.ieee802.org/3/WG_tools/templates/Task_Force_agenda_V3p9.pptx:

- Instruct the WG Secretary to record in the minutes of the relevant WG meeting:
 - That the foregoing information was provided and that slides 1 through 4 (and this slide
 0, if applicable) were shown;
 - That the chair or designee provided an opportunity for participants to identify patent claim(s)/patent application claim(s) and/or the holder of patent claim(s)/patent application claim(s) of which the participant is personally aware and that may be essential for the use of that standard
 - Any responses that were given, specifically the patent claim(s)/patent application claim(s) and/or the holder of the patent claim(s)/patent application claim(s) that were identified (if any) and by whom.

10:08am: Call for patents was made, none responded.

10:11am: Opening agenda slides complete. The meeting moves on to presentations.

Presentations/Discussion.

10:13am: Presentation 1: 802.3 Multidrop Mixing Segment Specifications, Chris DiMinico,

https://www.ieee802.org/3/da/public/061522/diminico SPMD 01 06152022.pdf

10:39am: Q&A

11:07am: end of presentation

11:07am: Presentation 2: 802.3 Multidrop Mixing Segment Specifications BASELINE, Chris DiMinico, https://www.ieee802.org/3/da/public/061522/diminico SPMD 02 06152022.pdf

11:15am: Q&A

11:21am: end of presentation

11:21 The Chair announces that a motion will be made in the next IEEE P802.3da interim meeting scheduled for June 29 to accept the file of presentation #2 as baseline for inclusion in the draft.

11:22 The Chair moved on to closing business, pointing out that the timeline has slipped yet again. He briefly discussed the work items and asked if anyone planned to present on any of the work items in the next meeting. One responded. The Chair reminds this is a contribution driven group and that without member participation, the standard will stagnate and die.

Next meeting: 29 June 2022, 10:00am EDT.

11:25am: Having exhausted the agenda, the Chair adjourned the meeting.

Meeting closed - 11:25am

Attendees (from Webex + chat)

Name	Employer	Affiliation	Attended 15 June
Bob Voss	Panduit Corp.	Panduit Corp.	Y
Chad Jones	Cisco Systems, Inc.	Cisco Systems, Inc.	Y
Chris DiMinico	MC Communications	PHY-SI/SenTekse	Y
Dave Hess	Cord Data	Cord Data	Υ
David D. Brandt	Rockwell Automation	Rockwell Automation	Y
Denis Beaudoin	Texas Instruments	Texas Instruments	Υ
Fred Dawson	Chemours	Chemours	Υ
Geoff Thompson	GraCaSI S.A.	Independent	Y
Gergely Huszak	Kone	Kone	Y
Harry Aller	Innovative Lighting	Innovative Lighting	Υ
Jason Potterf	Cisco Systems, Inc.	Cisco Systems, Inc.	Υ
Jerome BRENGUIER	Schneider Electric	Schneider Electric	Υ
Ken Schneider	Telebyte, Inc	Telebyte, Inc	Υ
Kent Lennartsson	Kvaser AB	Kvaser AB	Υ
Kiyoshi Saito	Furukawa Electric	Furukawa Electric	Υ
Paul Vanderlaan	UL	UL	Υ
Rich Boyer	Aptiv	Aptiv	Y
Rick Frosch	Phihong	Phihong	Y
Scott Wade	DALI Alliance/DiiA/WadeLux	DALI Alliance/DiiA/WadeLux	Υ
Simon Mark	Würth Elektronik	Würth Elektronik	Y
Tim Baggett	Microchip Technology, Inc.	Microchip Technology, Inc.	Υ
Valerie Maguire	Siemon	Siemon	Υ

Name	Employer	Affiliation	Attended 15 June
Victor Renteria	Bel/TRP	Bel/TRP	Y
Walter Downey	Dialog	Dialog	Υ
Wayne Larsen	CommScope	CommScope	Υ
Wojciech Koczwara	Rockwell Automation	Rockwell Automation	Υ
Woojung Huh	Microchip Technology, Inc.	Microchip Technology, Inc.	Υ
Yan Zhuang	Huawei	Huawei	Υ
Yusuke Yano	NITech	NITech	Y
Attendees			30